# Onsemi

## FFSH5065A-F155

#### Description

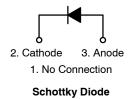
Silicon Carbide (SiC) Schottky Diodes use a completely new technology that provides superior switching performance and higher reliability compared to Silicon. No reverse recovery current, temperature independent switching characteristics, and excellent thermal performance sets Silicon Carbide as the next generation of power semiconductor. System benefits include highest efficiency, faster operating frequency, increased power density, reduced EMI, and reduced system size & cost.

#### Features

- Max Junction Temperature 175°C
- Avalanche Rated 240 mJ
- High Surge Current Capacity
- Positive Temperature Coefficient
- Ease of Paralleling
- No Reverse Recovery/No Forward Recovery
- No Reverse Recovery/No Forward Recovery
  These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant
  Applications

  General Purpose
  SMPS, Solar Inverter, UPS
  Power Switching Circuits

  A YWW ZZ FFSH5





5065A	= Assembly Plant Code = Date Code (Year & Week) = Lot Code = Specific Device Code

FFSH 5065A

#### **ORDERING INFORMATION**

See detailed ordering and shipping information on page 2 of this data sheet.

#### FFSH5065A-F155

Symbol	Parameter	Value	Unit	
V <sub>RRM</sub>	Peak Repetitive Reverse Voltage		650	V
E <sub>AS</sub>	Single Pulse Avalanche Energy (Note 1)		240	mJ
١ <sub>F</sub>	Continuous Rectified Forward Current @ T <sub>C</sub> < 144°C		50	А
	Continuous Rectified Forward Current @ $T_C$ <	135°C	60	
I <sub>F, Max</sub>	Non-Repetitive Peak Forward Surge Current	T <sub>C</sub> = 25°C, 10 μs	1183	А
		T <sub>C</sub> = 150°C, 10 μs	1127	А
I <sub>F,SM</sub>	Non-Repetitive Forward Surge Current	Half-Sine Pulse, t <sub>p</sub> = 8.3 ms	200	А
I <sub>F,RM</sub>	Repetitive Forward Surge Current	Half-Sine Pulse, t <sub>p</sub> = 8.3 ms	120	А
Ptot	Power Dissipation	T <sub>C</sub> = 25°C	429	W
		T <sub>C</sub> = 150°C	72	W
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range	÷	-55 to +175	J°C
	TO-247 Mounting Torque, M3 Screw		60	> Ncm

#### ABSOLUTE MAXIMUM RATINGS (T<sub>C</sub> = 25°C unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 1.  $E_{AS}$  of 240 mJ is based on starting  $T_J = 25^{\circ}C$ , L = 0.5 mH,  $I_{AS} = 31$  A, V = 50 V.

#### **THERMAL CHARACTERISTICS**

THERMAL CI	HARACTERISTICS	
Symbol	Parameter	Unit
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction-to-Case, Max. (Note 1) 0.35	°C/W

#### ELECTRICAL CHARACTERISTICS (T<sub>C</sub> = 25°C unless otherwise noted)

Symbol	Parameter	Test Condition	Min	Тур	Max	Unit
V <sub>F</sub>	Forward Voltage	$I_{\rm F} = 50  \text{A},  T_{\rm C} = 25^{\circ} \text{C}$	2 <u>-11</u>	1.51	1.75	V
	CV	$I_{\rm F} = 50$ A, $T_{\rm C} = 125^{\circ}{\rm C}$	0	1.67	2.0	
		H <sub>F</sub> = 50 A, T <sub>C</sub> = 175°C	-	1.82	2.4	
I <sub>R</sub>	Reverse Current	V <sub>R</sub> = 650 V, T <sub>C</sub> = 25°C	-	-	200	μΑ
		V <sub>R</sub> = 650 V, T <sub>C</sub> = 125°C	-	-	400	
		V <sub>R</sub> = 650 V, T <sub>C</sub> = 175°C	-	-	600	
$Q_C$	Total Capacitive Charge	V = 400 V	-	147	-	nC
С	Total Capacitance	V <sub>R</sub> = 1 V, f = 100 kHz	_	2530	-	pF
14		V <sub>R</sub> = 200 V, f = 100 kHz	_	271	-	
*		V <sub>R</sub> = 400 V, f = 100 kHz	-	211	-	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

#### **ORDERING INFORMATION**

Part Number	Top Marking	Package	Packing Method	Quantity
FFSH5065A-F155	FFSH5065A	TO-247-3LD (Pb-Free/Halogen Free)	Tube	30 Units

#### FFSH5065A-F155

#### **TYPICAL CHARACTERISTICS**

(T<sub>J</sub> = 25°C UNLESS OTHERWISE NOTED)

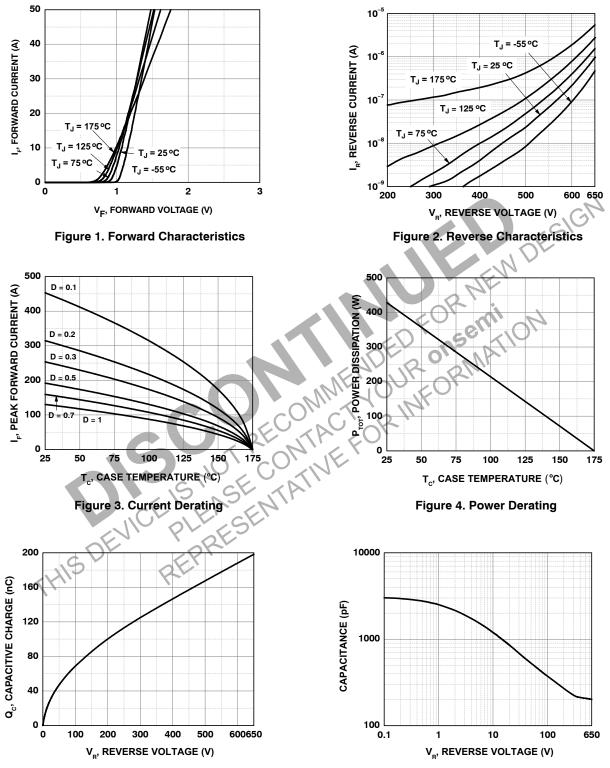




Figure 6. Capacitance vs. Reverse Voltage

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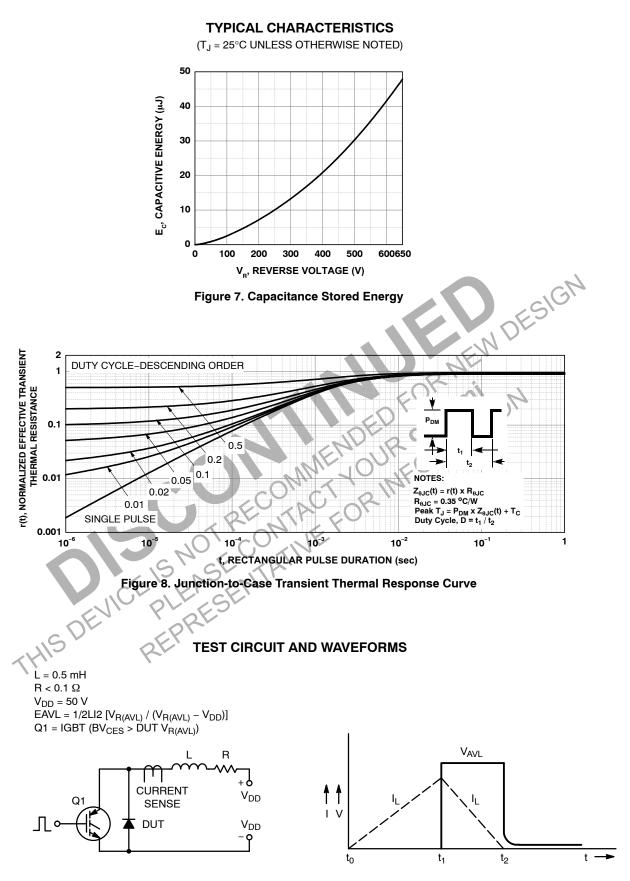
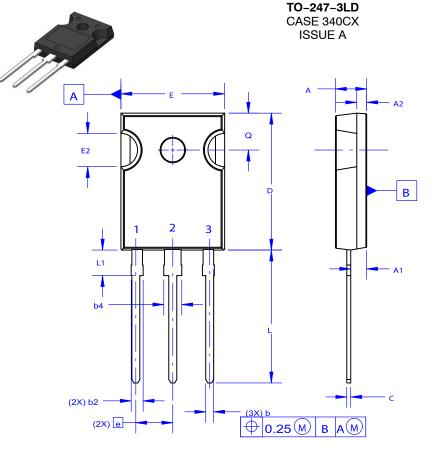


Figure 9. Unclamped Inductive Switching Test Circuit & Waveform





NOTES: UNLESS OTHERWISE SPECIFIED.

- A. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD
- FLASH, AND TIE BAR EXTRUSIONS. B. ALL DIMENSIONS ARE IN MILLIMETERS.
- C. DRAWING CONFORMS TO ASME Y14.5 2009.
- D. DIMENSION A1 TO BE MEASURED IN THE REGION DEFINED BY L1.
- E. LEAD FINISH IS UNCONTROLLED IN THE REGION DEFINED BY L1.

Υ

### GENERIC **MARKING DIAGRAM\*** Х



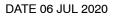
XXXXX	= Specific Device Code
Α	= Assembly Location

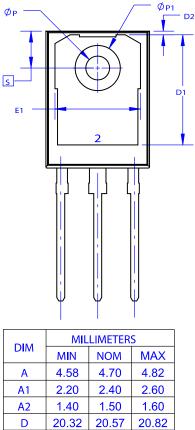
- = Assembly Location
- = Year ww
  - = Work Week
- G = Pb-Free Package

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ", may or may not be present. Some products may not follow the Generic Marking.

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DESCRIPTION:	TO-247-3LD		PAGE 1 OF 1	

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DIM	MIL	MILLIMETERS		
DIM	MIN	NOM	MAX	
Α	4.58	4.70	4.82	
A1	2.20	2.40	2.60	
A2	1.40	1.50	1.60	
D	20.32	20.57	20.82	
E	15.37	15.62	15.87	
E2	4.96	5.08	5.20	
е	~	5.56	~	
L	19.75	20.00	20.25	
L1	3.69	3.81	3.93	
ØР	3.51	3.58	3.65	
Q	5.34	5.46	5.58	
S	5.34	5.46	5.58	
b	1.17	1.26	1.35	
b2	1.53	1.65	1.77	
b4	2.42	2.54	2.66	
С	0.51	0.61	0.71	
D1	13.08	~	~	
D2	0.51	0.93	1.35	
E1	12.81	~	~	
Ø <b>P</b> 1	6.60	6.80	7.00	

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